Applications of Thin Films in Microelectronics

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Deadline for manuscript
submissions:
closed (31 January 2022)

Message from the Guest Editor

The main aim of this Special Issue is to seek high-quality submissions that highlight emerging applications, materials synthesis, and the fabrication process, which address recent breakthroughs in the microelectronic system. The topics of interest include but are not limited to:

- Searching and investigating various types of applications of thin films in electronics;
- Advanced fabrication processes and characterizations;
- Research into new synthesis methods;
- Analysis of film behaviors;
- Robust and reliable novel geometrical designs in microelectronics

Welcome to contribute!

SpecialIssue

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Message from the Editor-in-Chief

Electronics is a multidisciplinary journal designed to appeal to a diverse audience of research scientists, practitioners, and developers in academia and industry. The journal is devoted to fast publication of latest technological breakthroughs, cutting-edge developments, and timely reviews of current and emerging technologies related to the broad field of electronics. Experimental and theoretical results are published as regular peer-reviewed articles or as articles within Special Issues guest-edited by leading experts in selected topics of interest.

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